## 505397929 03/28/2019

## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:		NEW ASSIGNMENT	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:		ASSIGNMENT	ASSIGNMENT		
CONVEYING PARTY DA	ΑΤΑ				
		Name	Execution Date		
SUNG-WEI LEE			03/14/2019		
RECEIVING PARTY DA	ТА				
Name:	ASIA VITAL COMPONENTS (CHINA) CO., LTD.				
Street Address:	WEST	WEST INDUSTRIAL PARK, XINYANG COMMUNITY			
Internal Address:	SHAJI	SHAJING BRANCH, BAOAN DISTRICT			
City:	SHEN	SHENZHEN			
State/Country:	CHINA	CHINA			
Property Type		Number			
Application Number:		16367269			
	e sent t	o the e-mail address first; if that is uns d; if that is unsuccessful, it will be sent ip@tunhwa.com.tw ASIA VITAL COMPONENTS (CHINA) CO 7FL., NO. 283, SEC. 2, FUSHING S. RD TAIPEI CITY, TAIWAN 106	t <i>via US Mail.</i> O., LTD.		
		SUNG-WELLEE			
		SUNG-WEI LEE			
NAME OF SUBMITTER: SIGNATURE: DATE SIGNED:		SUNG-WEI LEE /Sung-Wei Lee/ 03/28/2019			

ATTORNEY/DOCKET NO:

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#### ASSIGNMENT BY INVENTOR(S) OF U.S. APPLICATION

WHEREAS, I am the original, first and sole inventor and I own (if only one name is listed below) or an original, first and joint inventor and the joint inventors own (if plural names are listed below) (referred to as "ASSIGNOR" below) the subject matter which is claimed and for which a patent is sought on the invention (referred to as the "INVENTION" below) entitled:

# Title: WATER BLOCK MOUNTING HOLDER WITH REINFORCED STRUCTURE

the specification of which (check one):

X i	s executed on even	date herewith.	
<u>ч</u>	was filed on (day-month-year)		as U.S. Application Number
۲ ۲	was filed on (day-month-year)		as PCT Application Number
	vas executed on the day-month-year)	following date(s)	
	WHEREAS,	ar varis addition	DARRE (CHUR) & CO. Y TD.

### ASIA VITAL COMPONENTS (CHINA) CO., LTD.

having a postal address of

Sheuzhen City, China

West Industrial Park, Xinyang Community, Shajing Branch, Baoan District,

(referred to as "ASSIGNEE" below) desires to acquire the entire right, title and interest in and to the same in the U.S.;

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged, ASSIGNOR, by these presents does sell, assign and transfer unto ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all patents granted on any division, continuation continuation-in-part and reissue of said application.

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent applications in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE's expense, to identify and communicate to ASSIGNEE at ASSIGNEE's request documents and information concerning the INVENTION that are within ASSIGNOR's possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR's obligations under this instrument shall extend to ASSIGNOR's heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all patents referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title 'and interest in and to the same, for ASSIGNEE's sole use and behoof; and for the use and behoof of 'ASSIGNEE's legal representatives and successors, to the full end of the term for which such patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

Full Name of First or Sole Inventor	Post Office Address	
Sung-Wei Lee West Industrial Park, Xinyang Community, Shajing Brz Baoan District, Shenzhen City, China		
itizenship Residence (city, and either state or foreign country, MPEP \$60.		
Taiwan (R.O.C.)West Industrial Park, Xinyang Community, Shajing I Baoan District, Shenzhen City, China		
Date		
March 14, 2019	Dung-Wei Lee	

See following page(s) for additional joint inventors.

### PATENT REEL: 048721 FRAME: 0483

**RECORDED: 03/28/2019**